

# 1200V 80mohm Silicon Carbide Power MOSFET AK1CK2M080WAMH-A

## Features:

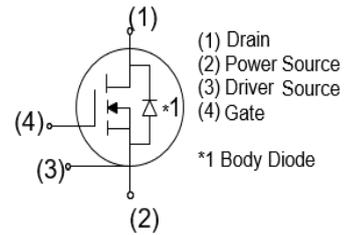
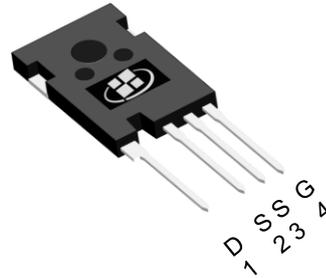
- Low on-resistance
- Fast switching speed with low capacitances
- Fast intrinsic diode with low reverse recovery (Qrr)
- Halogen-free, RoHS compliant
- AEC-Q101 Qualified

## Applications:

- Motor drives
- Switched mode power supplies

## Key Performance Parameters:

Parameter	Value	Unit
$V_{DS}$	1200	V
$R_{DS(on), TYP} @ V_{GS} = 15\text{ V}$	118	m $\Omega$
$R_{DS(on), TYP} @ V_{GS} = 18\text{ V}$	90	m $\Omega$
$I_D$	26.5	A
$P_D$	136	W



## Ordering Information:

Ordering Code	Package Type	Marking Code	Form	Packing
AK1CK2M080WAMH-A	TO-247-4L	1CK2M080WAMH	Tube	See the detail package information

**Maximum Ratings** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Value	Units
$V_{DS}$	Drain-Source Voltage	1200	V
$I_D$	Drain Current - Continuous ( $T_C = 25^\circ\text{C}$ ) <sup>(Note 1)</sup>	26.5	A
	Drain Current - Continuous ( $T_C = 100^\circ\text{C}$ ) <sup>(Note 1)</sup>	18	A
$I_{DM}$	Drain Current - Pulsed <sup>(Note 2)</sup>	66	A
$V_{GS}$	Gate - Source Voltage (dynamic)	-12/+24	V
$V_{GS}$	Gate - Source Voltage (static)	-6/+18	V
$P_D$	Power Dissipation ( $T_C = 25^\circ\text{C}$ )	136	W
$T_J, T_{STG}$	Operating and Storage Temperature Range	-55 to +175	$^\circ\text{C}$

**Thermal Characteristics**

Symbol	Parameter	Value	Units
$R_{\theta JC}$	Thermal Resistance, Junction - to - Case, Steady - State	1.1	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance, Junction - to - Ambient, Steady - State	40	$^\circ\text{C/W}$

**Notes:**

1. The max drain current limited by maximum junction temperature
2. Repetitive Rating: Pulse width limited by maximum junction temperature

<b>Electrical Characteristics</b> ( $T_J = 25^\circ\text{C}$ unless otherwise noted)						
Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
<b>Static Characteristics</b>						
$V_{(BR)DSS}$	Drain - Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_D = 100\ \mu\text{A}$	1200			V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = 1200\text{ V}, V_{GS} = 0\text{ V}$		5	50	$\mu\text{A}$
$I_{GSS}$	Gate Leakage Current	$V_{GS} = +24\text{ V}, V_{DS} = 0\text{ V}$			100	nA
		$V_{GS} = -12\text{ V}, V_{DS} = 0\text{ V}$			-100	nA
$V_{GS(th)}$	Gate Threshold voltage	$V_{DS} = V_{GS}, I_D = 5\text{ mA}$	2	3.2	4.5	V
		$V_{DS} = V_{GS}, I_D = 5\text{ mA}, T_J = 175^\circ\text{C}$		2.3		V
$R_{DS(ON)}$	Drain-Source on-state resistance	$V_{GS} = 15\text{ V}, I_D = 20\text{ A}$		118	155	m $\Omega$
		$V_{GS} = 15\text{ V}, I_D = 20\text{ A}, T_J = 175^\circ\text{C}$		158		m $\Omega$
$R_{DS(ON)}$	Drain-Source on-state resistance	$V_{GS} = 18\text{ V}, I_D = 20\text{ A}$		90	118	m $\Omega$
		$V_{GS} = 18\text{ V}, I_D = 20\text{ A}, T_J = 175^\circ\text{C}$		148		m $\Omega$
$g_{FS}$	Forward Transconductance	$V_{DS} = 20\text{ V}, I_D = 20\text{ A}$		12		S
		$V_{DS} = 20\text{ V}, I_D = 20\text{ A}, T_J = 175^\circ\text{C}$		11		S
<b>Dynamic Characteristics</b>						
$C_{iss}$	Input Capacitance	$V_{DS} = 800\text{ V}, V_{GS} = 0\text{ V}, F = 100\text{ kHz}, V_{AC} = 25\text{ mV}$		1275		pF
$C_{oss}$	Output Capacitance			48		pF
$C_{riss}$	Reverse Transfer Capacitance			3.5		pF
$E_{oss}$	$C_{OSS}$ Stored Energy			20		$\mu\text{J}$
$R_g$	Gate Resistance	$F = 1\text{ MHz}, V_{AC} = 25\text{ mV}$		2.9		$\Omega$
$Q_{gs}$	Gate-Source Charge	$V_{DS} = 800\text{ V}, I_D = 20\text{ A}, V_{GS} = -5/+18\text{ V}$		17		nC
$Q_{gd}$	Gate-Drain Charge			28		nC
$Q_g$	Total Gate Charge			65		nC

Switching Characteristics						
Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
$t_{d(on)}$	Turn On Delay Time	$V_{DD} = 800\text{ V}$ , $I_D = 20\text{ A}$ , $V_{GS} = -4/+18\text{ V}$ , $R_{G,EXT} = 5\ \Omega$ $L = 100\ \mu\text{H}$ Diode: Body Diode at $V_{GS} = -4\text{V}$		9.5		ns
$t_r$	Rise Time			12		ns
$t_{d(off)}$	Turn Off Delay Time			21		ns
$t_f$	Fall Time			9.5		ns
$E_{on}$	Turn On Energy			182		$\mu\text{J}$
$E_{off}$	Turn Off Energy			72.5		$\mu\text{J}$
$t_{d(on)}$	Turn On Delay Time	$V_{DD} = 800\text{ V}$ , $I_D = 20\text{ A}$ , $V_{GS} = -4/+18\text{ V}$ , $R_{G,EXT} = 20\ \Omega$ $L = 100\ \mu\text{H}$ Diode: Body Diode at $V_{GS} = -4\text{V}$		28.5		ns
$t_r$	Rise Time			21		ns
$t_{d(off)}$	Turn Off Delay Time			45		ns
$t_f$	Fall Time			18		ns
$E_{on}$	Turn On Energy			420		$\mu\text{J}$
$E_{off}$	Turn Off Energy			167		$\mu\text{J}$

**Drain-Source Diode Characteristics** ( $T_J = 25\text{ }^\circ\text{C}$  unless otherwise noted)

$I_S$	Maximum Continuous Drain-Source Diode Forward Current			26.5	A
$I_{SM}$	Maximum Pulsed Drain-Source Diode Forward Current			66	A
$V_{SD}$	Diode Forward Voltage	$V_{GS} = -4\text{ V}$ , $I_{SD} = 10\text{ A}$		4.6	V
		$V_{GS} = -4\text{ V}$ , $I_{SD} = 10\text{ A}$ , $T_J = 175\text{ }^\circ\text{C}$		4	V
$I_{rrm}$	Peak Reverse Recovery Current	$V_{GS} = -4\text{ V}$ , $I_{SD} = 20\text{ A}$ , $V_R = 800\text{ V}$ , $di/dt = 1930\text{ A}/\mu\text{s}$		21	A
$t_{rr}$	Reverse Recovery Time			15	ns
$Q_{rr}$	Reverse Recovery Charge			183	nC

## Electrical Characteristics Diagrams

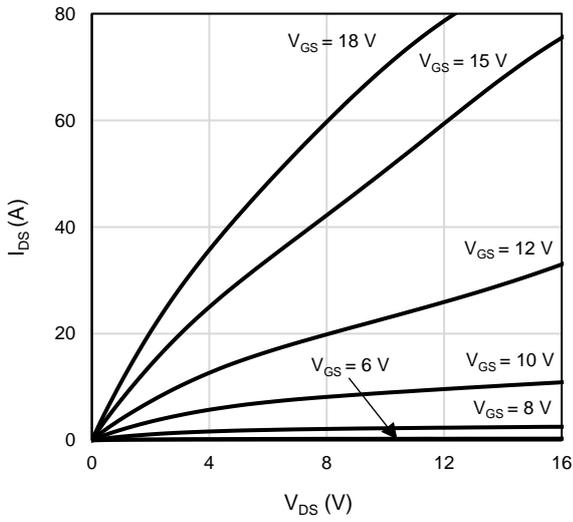


Figure 1: Output Characteristics  $T_J = -40^\circ\text{C}$

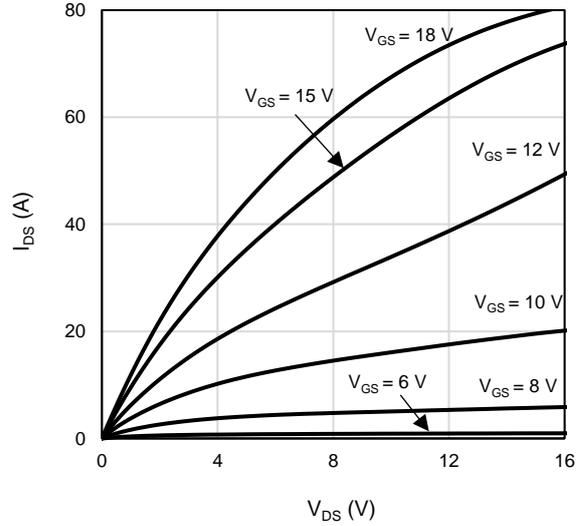


Figure 2: Output Characteristics  $T_J = 25^\circ\text{C}$

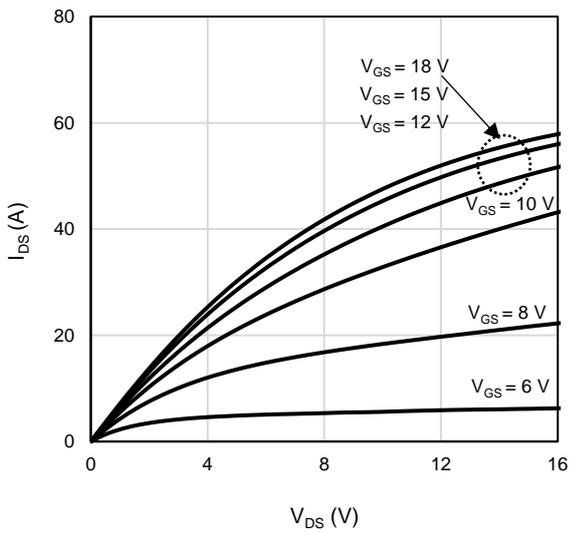


Figure 3: Output Characteristics  $T_J = 175^\circ\text{C}$

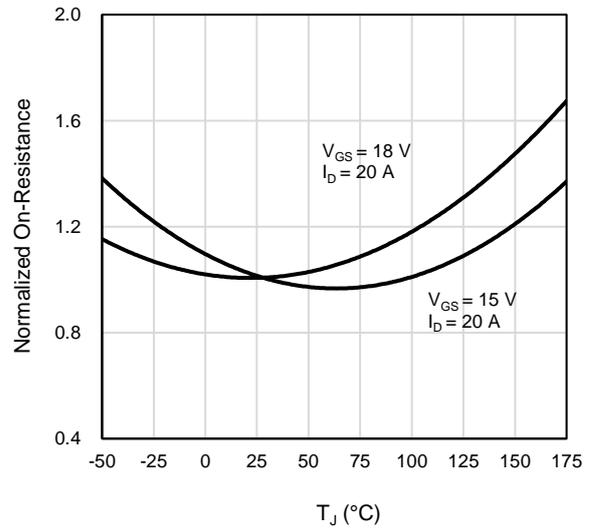


Figure 4: Normalized On-Resistance vs. Temperature

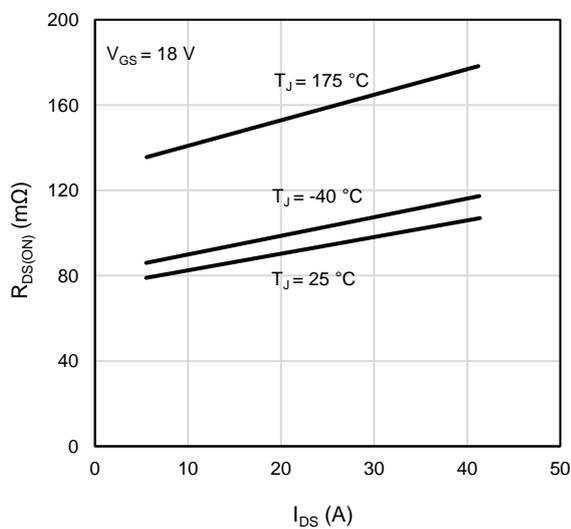


Figure 5: On-Resistance vs. Drain Current For Various Temperatures

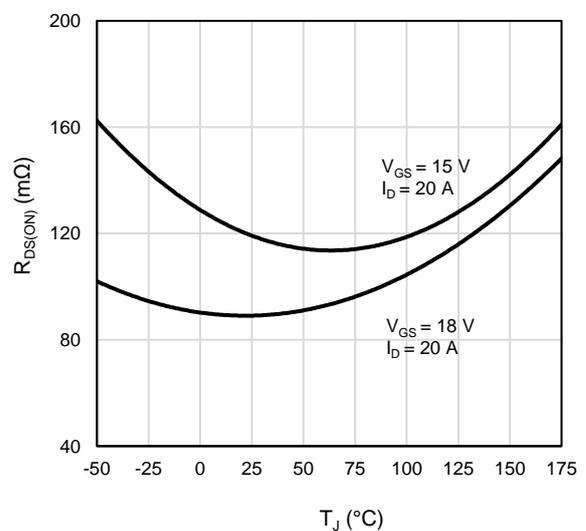


Figure 6: On-Resistance vs. Temperature

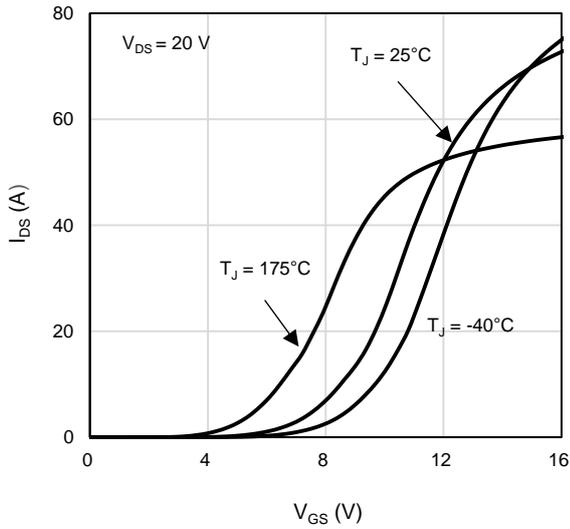


Figure 7: Transfer Characteristics For Various Junction Temperature

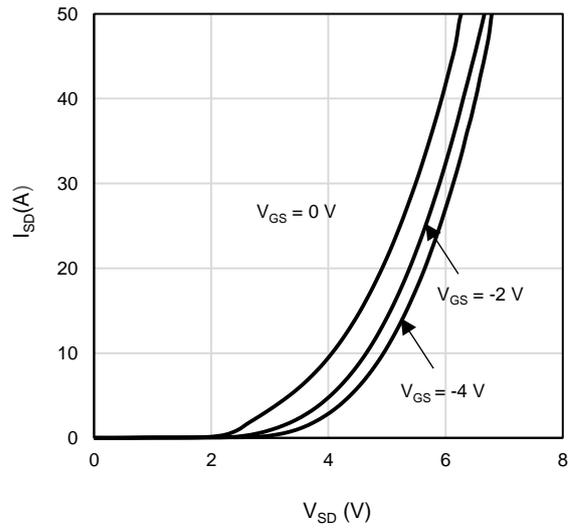


Figure 8: Body Diode Characteristics at  $-40^\circ\text{C}$

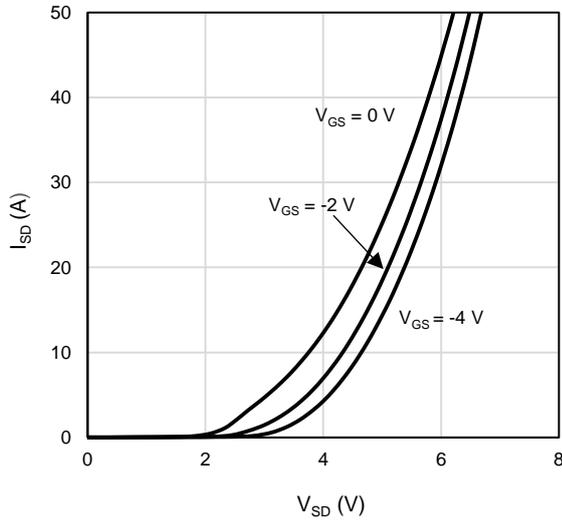


Figure 9: Body Diode Characteristics at  $25^\circ\text{C}$

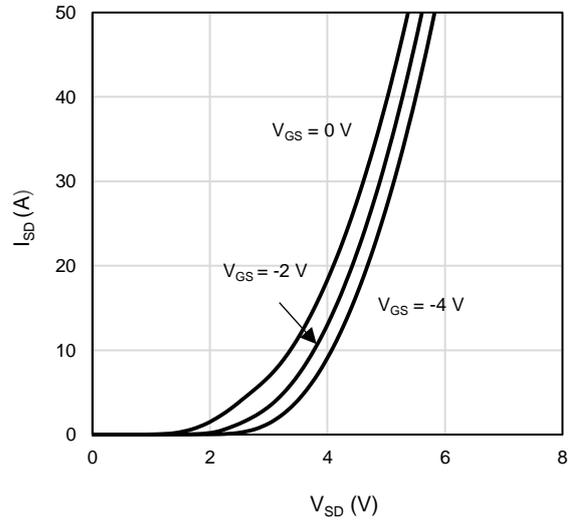


Figure 10: Body Diode Characteristics at  $175^\circ\text{C}$

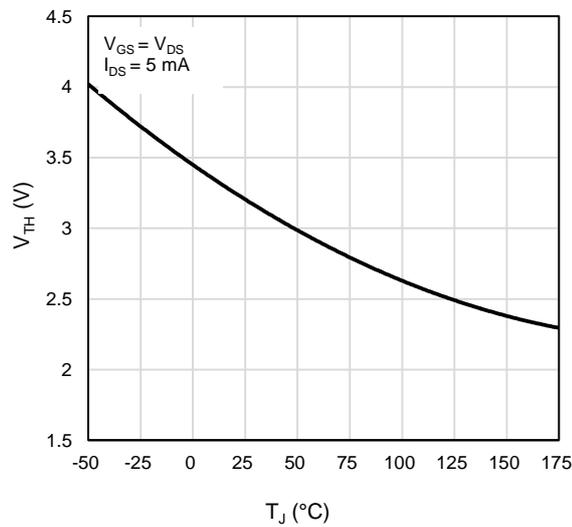


Figure 11: Threshold Voltage vs. Temperature

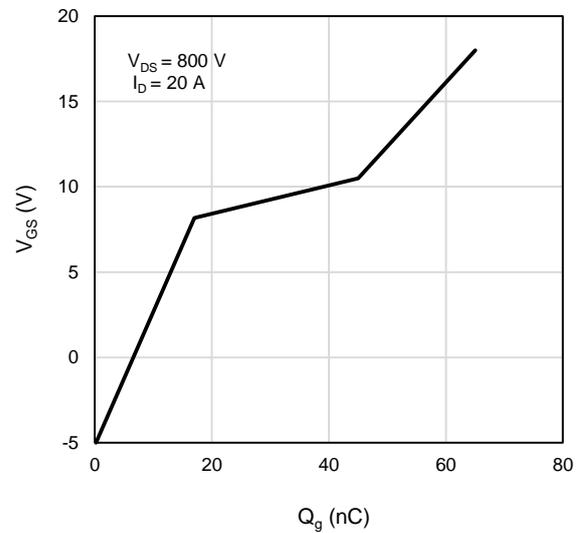


Figure 12: Gate-Charge Characteristics

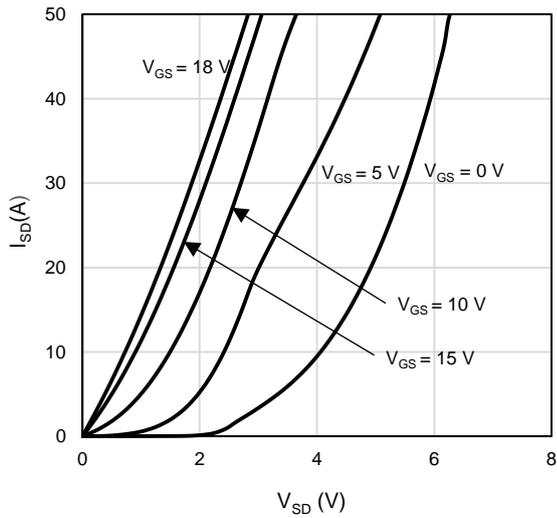


Figure 13: 3rd Quadrant Characteristics at -40°C

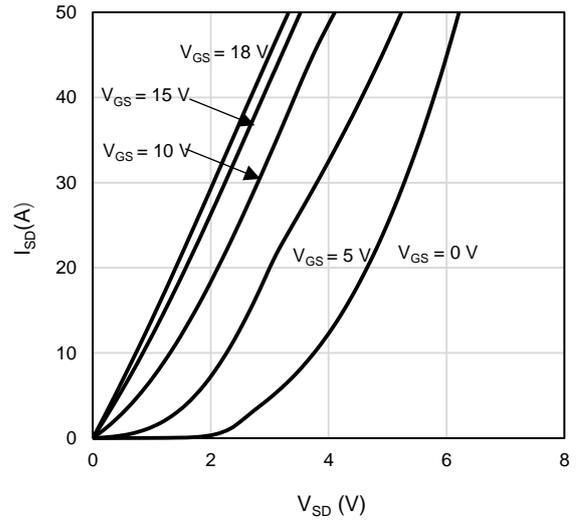


Figure 14: 3rd Quadrant Characteristics at 25°C

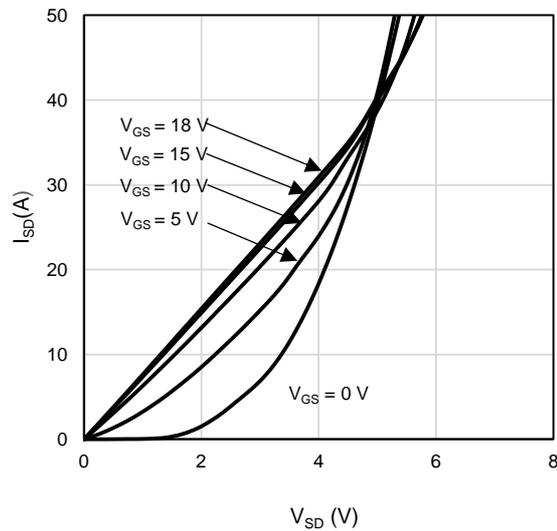


Figure 15: 3rd Quadrant Characteristics at 175°C

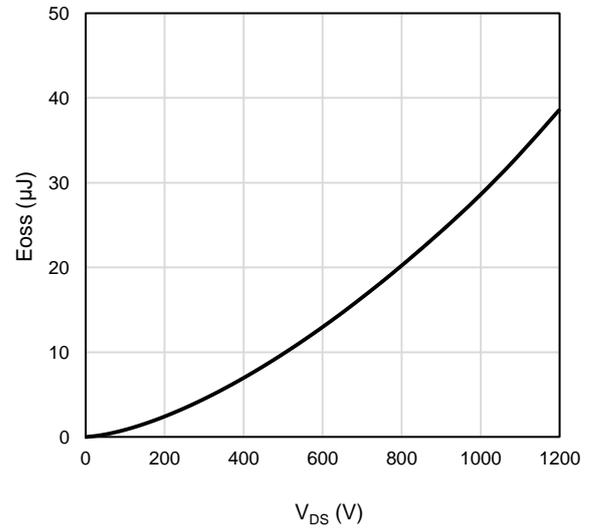


Figure 16: Output Capacitor Stored Energy

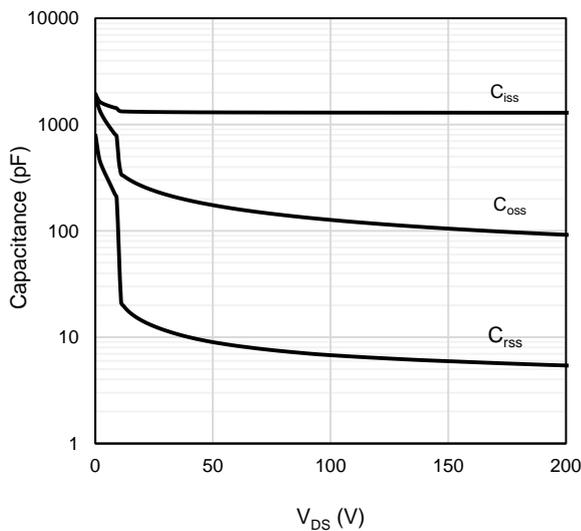


Figure 17: Capacitance Characteristics (0 - 200 V)

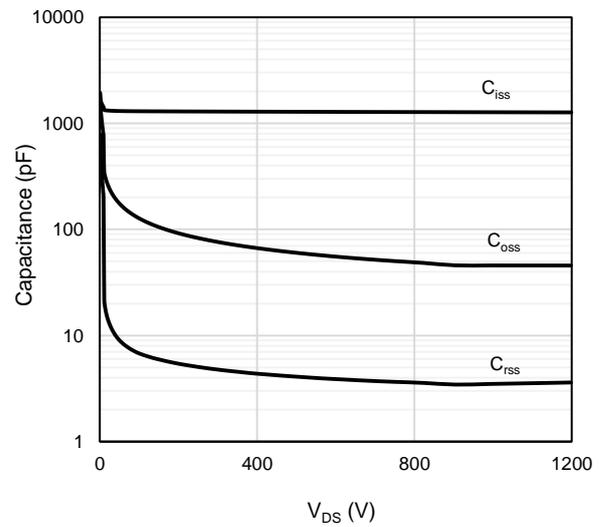


Figure 18: Capacitance Characteristics (0 - 1200 V)

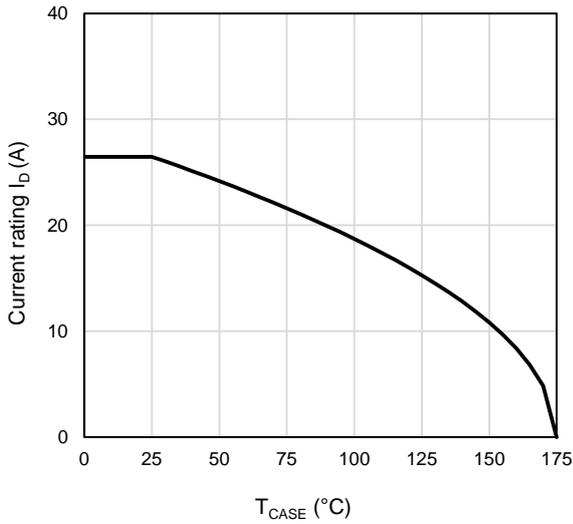


Figure 19: Current De-rating

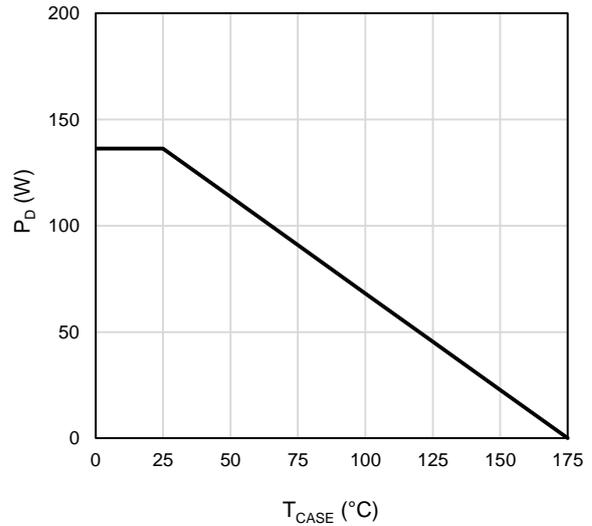


Figure 20: Maximum Power Dissipation Derating vs. Case Temperature

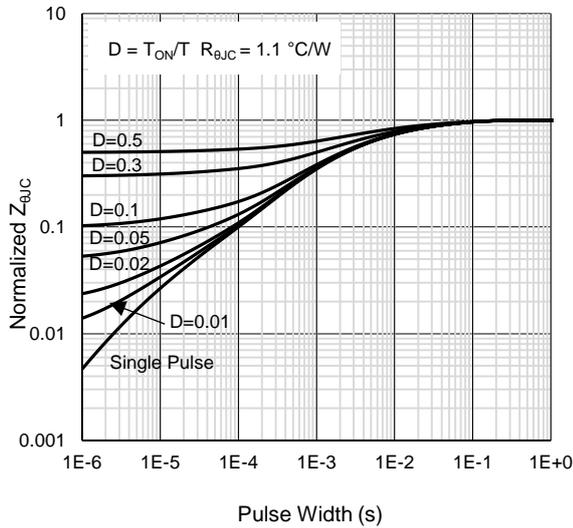


Figure 21: Normalized Maximum Transient Thermal Impedance

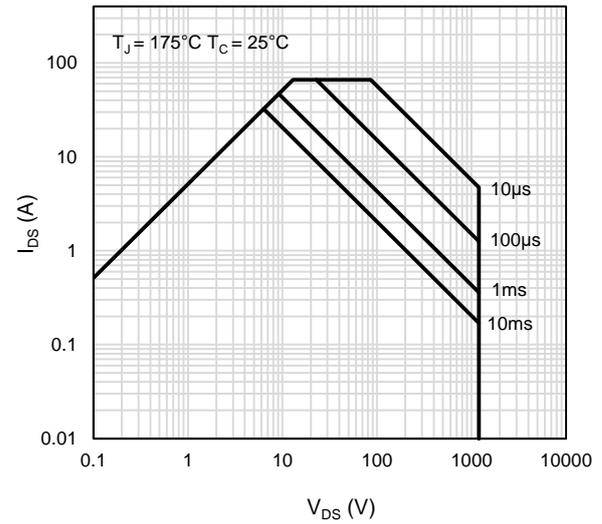


Figure 22: Maximum Forward Biased Safe Operating Area

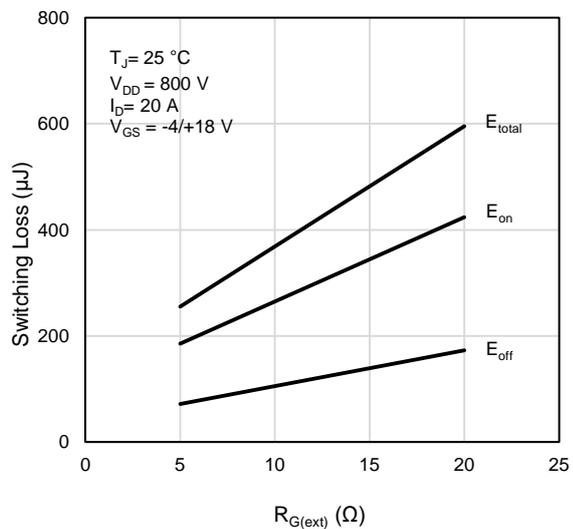


Figure 23: Clamped Inductive Switching Energy vs.  $R_{G(ext)}$

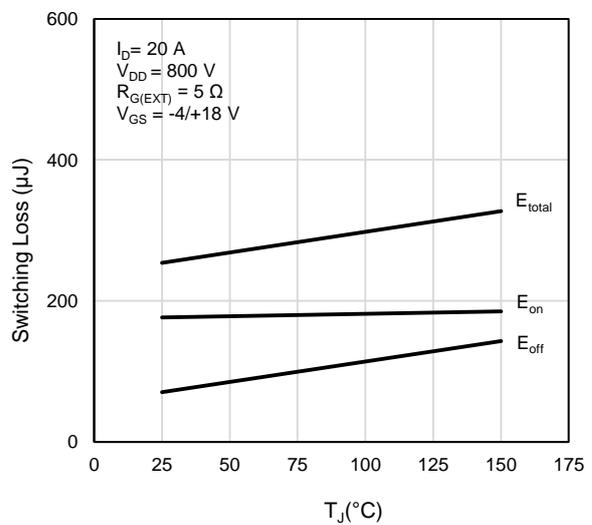


Figure 24: Clamped Inductive Switching Energy vs.  $T_J$

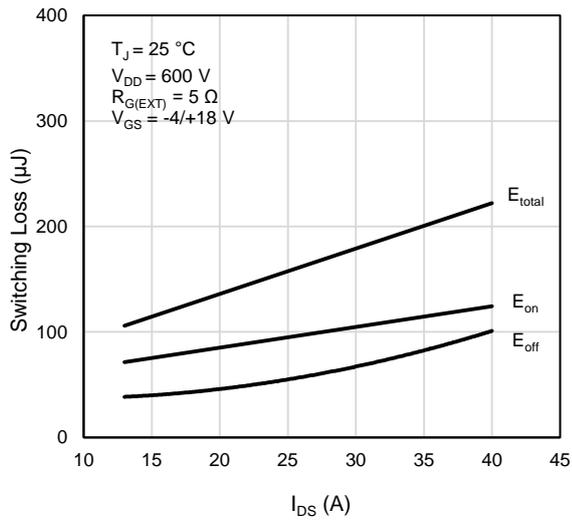


Figure 25: Clamped Inductive Switching Energy vs. Drain Current ( $V_{DD} = 600\text{ V}$ )

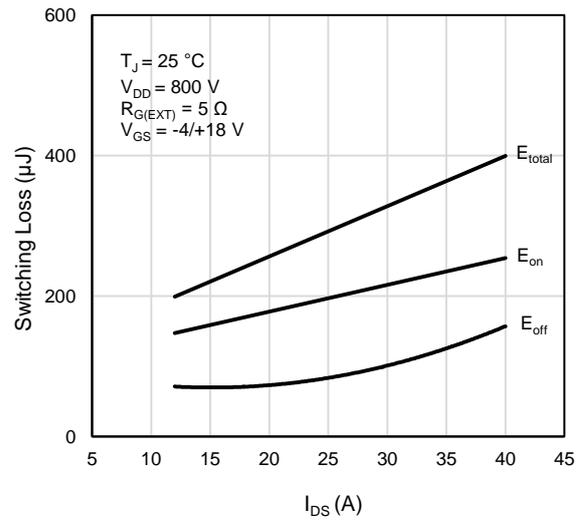


Figure 26: Clamped Inductive Switching Energy vs. Drain Current ( $V_{DD} = 800\text{ V}$ )

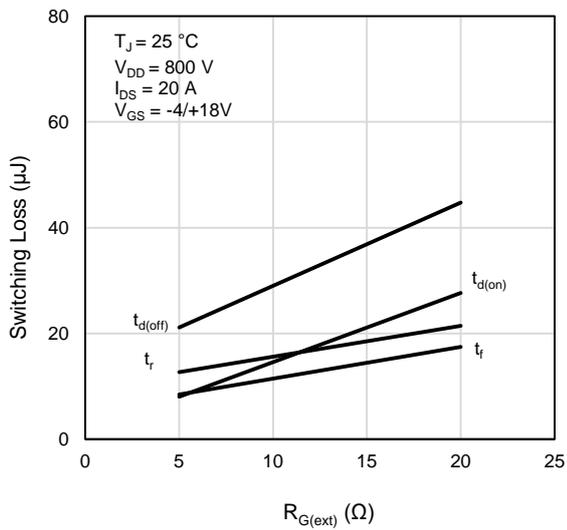
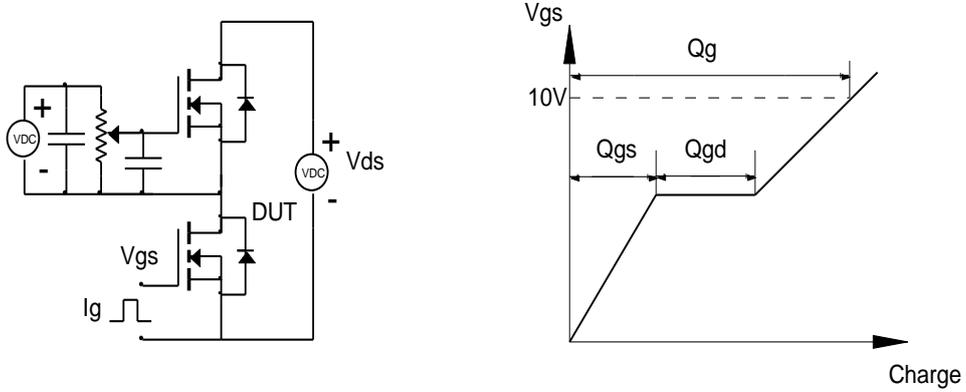


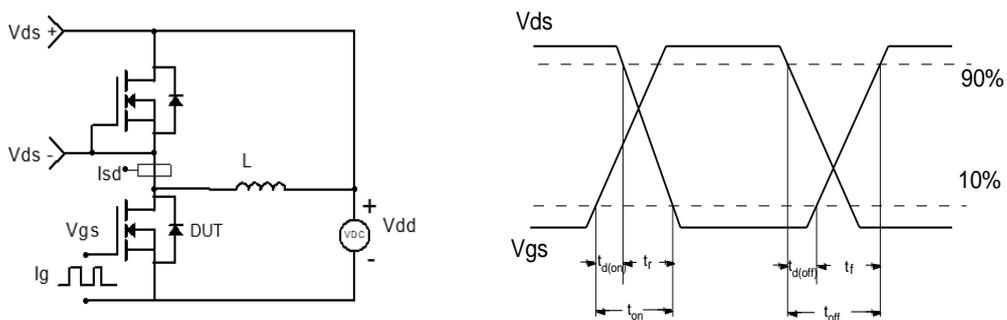
Figure 27: Switching Time vs.  $R_{G(EXT)}$

# Test Circuit and Waveform

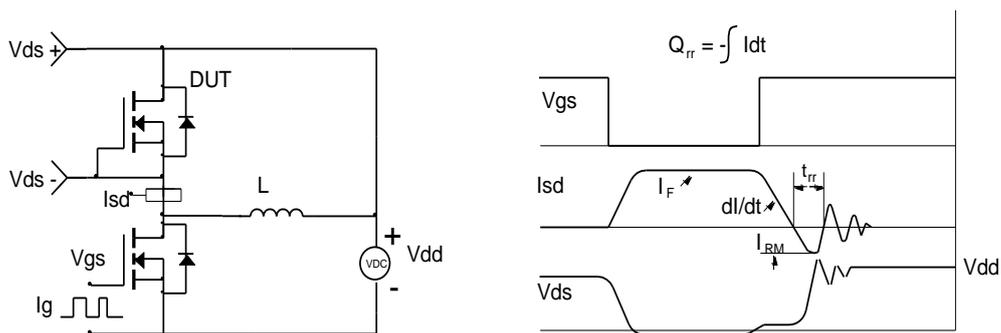
## Gate Charge Test Circuit & Waveform



## Clamped Inductive Switching Test Circuit & Waveforms



## Diode Recovery Test Circuit & Waveforms



**Revision History**

Revision	Released	Remark
Rev.1.0	2025	Initial Release

**Disclaimer**

The information given in this document describes the independent performance of the product, but similar performance is not guaranteed under other working conditions, and cannot be guaranteed when installed with other products or equipment. To achieve the required performance of the product in actual scenarios, the customer should conduct a complete application test to assess the functionality of the product.

Alkaidsemi assumes no responsibility for equipment failures result from using products at values that exceed the ratings, operating conditions, or other parameters listed in the product specifications.

The product described in this specification is not applicable for aerospace or other applications which requires high reliability. Customers using or selling these products for use in medical, life-saving, or life-sustaining applications do so at their own risk and agree to fully indemnify.

Due to product or technical improvements, the information described or contained herein may be changed without prior notice.